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### **Understanding Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### **Details**

Product Status	Obsolete
Number of LABs/CLBs	1452
Number of Logic Elements/Cells	-
Total RAM Bits	-
Number of I/O	111
Number of Gates	24000
Voltage - Supply	2.25V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	144-LBGA
Supplier Device Package	144-FPBGA (13x13)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microsemi/a54sx16a-2fg144">https://www.e-xfl.com/product-detail/microsemi/a54sx16a-2fg144</a>

## Temperature Grade Offering

Package	A54SX08A	A54SX16A	A54SX32A	A54SX72A
PQ208	C,I,A,M	C,I,A,M	C,I,A,M	C,I,A,M
TQ100	C,I,A,M	C,I,A,M	C,I,A,M	
TQ144	C,I,A,M	C,I,A,M	C,I,A,M	
TQ176			C,I,M	
BG329			C,I,M	
FG144	C,I,A,M	C,I,A,M	C,I,A,M	
FG256		C,I,A,M	C,I,A,M	C,I,A,M
FG484			C,I,M	C,I,A,M
CQ208			C,M,B	C,M,B
CQ256			C,M,B	C,M,B

**Notes:**

1. C = Commercial
2. I = Industrial
3. A = Automotive
4. M = Military
5. B = MIL-STD-883 Class B
6. For more information regarding automotive products, refer to the SX-A Automotive Family FPGAs datasheet.
7. For more information regarding Mil-Temp and ceramic packages, refer to the HiRel SX-A Family FPGAs datasheet.

## Speed Grade and Temperature Grade Matrix

	F	Std	-1	-2	-3
Commercial	✓	✓	✓	✓	Discontinued
Industrial		✓	✓	✓	Discontinued
Automotive		✓			
Military		✓	✓		
MIL-STD-883B		✓	✓		

**Notes:**

1. For more information regarding automotive products, refer to the SX-A Automotive Family FPGAs datasheet.
2. For more information regarding Mil-Temp and ceramic packages, refer to the HiRel SX-A Family FPGAs datasheet.

Contact your Actel Sales representative for more information on availability.

## Other Architectural Features

### Technology

The Actel SX-A family is implemented on a high-voltage, twin-well CMOS process using  $0.22\text{ }\mu\text{/ }0.25\text{ }\mu$  design rules. The metal-to-metal antifuse is comprised of a combination of amorphous silicon and dielectric material with barrier metals and has a programmed ('on' state) resistance of  $25\text{ }\Omega$  with capacitance of  $1.0\text{ fF}$  for low signal impedance.

### Performance

The unique architectural features of the SX-A family enable the devices to operate with internal clock frequencies of 350 MHz, causing very fast execution of even complex logic functions. The SX-A family is an optimal platform upon which to integrate the functionality previously contained in multiple complex programmable logic devices (CPLDs). In addition, designs that previously would have required a gate array to meet performance goals can be integrated into an SX-A device with dramatic improvements in cost and time-to-market. Using timing-driven place-and-route tools, designers can achieve highly deterministic device performance.

### User Security

Reverse engineering is virtually impossible in SX-A devices because it is extremely difficult to distinguish between programmed and unprogrammed antifuses. In addition, since SX-A is a nonvolatile, single-chip solution, there is no configuration bitstream to intercept at device power-up.

The Actel FuseLock advantage ensures that unauthorized users will not be able to read back the contents of an Actel antifuse FPGA. In addition to the inherent strengths of the architecture, special security fuses that prevent internal probing and overwriting are hidden throughout the fabric of the device. They are located where they cannot be accessed or bypassed without destroying access to the rest of the device, making both invasive and more-subtle noninvasive attacks ineffective against Actel antifuse FPGAs.

Look for this symbol to ensure your valuable IP is secure (Figure 1-11).



Figure 1-11 • FuseLock

For more information, refer to Actel's *Implementation of Security in Actel Antifuse FPGAs* application note.

### I/O Modules

For a simplified I/O schematic, refer to Figure 1 in the application note, *Actel eX, SX-A, and RTSX-S I/Os*.

Each user I/O on an SX-A device can be configured as an input, an output, a tristate output, or a bidirectional pin. Mixed I/O standards can be set for individual pins, though this is only allowed with the same voltage as the input. These I/Os, combined with array registers, can achieve clock-to-output-pad timing as fast as 3.8 ns, even without the dedicated I/O registers. In most FPGAs, I/O cells that have embedded latches and flip-flops, requiring instantiation in HDL code; this is a design complication not encountered in SX-A FPGAs. Fast pin-to-pin timing ensures that the device is able to interface with any other device in the system, which in turn enables parallel design of system components and reduces overall design time. All unused I/Os are configured as tristate outputs by the Actel Designer software, for maximum flexibility when designing new boards or migrating existing designs.

SX-A I/Os should be driven by high-speed push-pull devices with a low-resistance pull-up device when being configured as tristate output buffers. If the I/O is driven by a voltage level greater than  $V_{CCA}$  and a fast push-pull device is NOT used, the high-resistance pull-up of the driver and the internal circuitry of the SX-A I/O may create a voltage divider. This voltage divider could pull the input voltage below specification for some devices connected to the driver. A logic '1' may not be correctly presented in this case. For example, if an open drain driver is used with a pull-up resistor to 5 V to provide the logic '1' input, and  $V_{CCA}$  is set to 3.3 V on the SX-A device, the input signal may be pulled down by the SX-A input.

Each I/O module has an available power-up resistor of approximately  $50\text{ k}\Omega$  that can configure the I/O in a known state during power-up. For nominal pull-up and pull-down resistor values, refer to Table 1-4 on page 1-8 of the application note *Actel eX, SX-A, and RTSX-S I/Os*. Just slightly before  $V_{CCA}$  reaches 2.5 V, the resistors are disabled, so the I/Os will be controlled by user logic. See Table 1-2 on page 1-8 and Table 1-3 on page 1-8 for more information concerning available I/O features.

## Related Documents

### Application Notes

*Global Clock Networks in Actel's Antifuse Devices*

[http://www.actel.com/documents/GlobalClk\\_AN.pdf](http://www.actel.com/documents/GlobalClk_AN.pdf)

*Using A54SX72A and RT54SX72S Quadrant Clocks*

[http://www.actel.com/documents/QCLK\\_AN.pdf](http://www.actel.com/documents/QCLK_AN.pdf)

*Implementation of Security in Actel Antifuse FPGAs*

[http://www.actel.com/documents/Antifuse\\_Security\\_AN.pdf](http://www.actel.com/documents/Antifuse_Security_AN.pdf)

*Actel eX, SX-A, and RTSX-S I/Os*

[http://www.actel.com/documents/AntifuseIO\\_AN.pdf](http://www.actel.com/documents/AntifuseIO_AN.pdf)

*Actel SX-A and RT54SX-S Devices in Hot-Swap and Cold-Sparing Applications*

[http://www.actel.com/documents/HotSwapColdSparing\\_AN.pdf](http://www.actel.com/documents/HotSwapColdSparing_AN.pdf)

*Programming Antifuse Devices*

[http://www.actel.com/documents/AntifuseProgram\\_AN.pdf](http://www.actel.com/documents/AntifuseProgram_AN.pdf)

### Datasheets

*HiRel SX-A Family FPGAs*

[http://www.actel.com/documents/HRSXA\\_DS.pdf](http://www.actel.com/documents/HRSXA_DS.pdf)

*SX-A Automotive Family FPGAs*

[http://www.actel.com/documents/SXA\\_Auto\\_DS.pdf](http://www.actel.com/documents/SXA_Auto_DS.pdf)

### User's Guides

*Silicon Sculptor User's Guide*

[http://www.actel.com/documents/SiliSculptII\\_Sculpt3\\_ug.pdf](http://www.actel.com/documents/SiliSculptII_Sculpt3_ug.pdf)

## Electrical Specifications

Table 2-5 • 3.3 V LVTTL and 5 V TTL Electrical Specifications

Symbol	Parameter	Commercial		Industrial		Units	
		Min.	Max.	Min.	Max.		
$V_{OH}$	$V_{CCI} = \text{Minimum}$ $V_I = V_{IH} \text{ or } V_{IL}$	( $I_{OH} = -1 \text{ mA}$ )	0.9 $V_{CCI}$	0.9 $V_{CCI}$		V	
	$V_{CCI} = \text{Minimum}$ $V_I = V_{IH} \text{ or } V_{IL}$	( $I_{OH} = -8 \text{ mA}$ )	2.4	2.4		V	
$V_{OL}$	$V_{CCI} = \text{Minimum}$ $V_I = V_{IH} \text{ or } V_{IL}$	( $I_{OL} = 1 \text{ mA}$ )	0.4	0.4		V	
	$V_{CCI} = \text{Minimum}$ $V_I = V_{IH} \text{ or } V_{IL}$	( $I_{OL} = 12 \text{ mA}$ )	0.4	0.4		V	
$V_{IL}$	Input Low Voltage		0.8	0.8		V	
$V_{IH}$	Input High Voltage		2.0	5.75	2.0	5.75	V
$I_{IL}/I_{IH}$	Input Leakage Current, $V_{IN} = V_{CCI} \text{ or GND}$		-10	10	-10	10	$\mu\text{A}$
$I_{OZ}$	Tristate Output Leakage Current		-10	10	-10	10	$\mu\text{A}$
$t_R, t_F$	Input Transition Time $t_R, t_F$		10	10		ns	
$C_{IO}$	I/O Capacitance		10	10		pF	
$I_{CC}$	Standby Current		10	20		mA	
IV Curve*	Can be derived from the IBIS model on the web.						

**Note:** \*The IBIS model can be found at <http://www.actel.com/download/ibis/default.aspx>.

Table 2-6 • 2.5 V LVCMS2 Electrical Specifications

Symbol	Parameter	Commercial		Industrial		Units	
		Min.	Max.	Min.	Max.		
$V_{OH}$	$V_{DD} = \text{MIN},$ $V_I = V_{IH} \text{ or } V_{IL}$	( $I_{OH} = -100 \mu\text{A}$ )	2.1	2.1		V	
	$V_{DD} = \text{MIN},$ $V_I = V_{IH} \text{ or } V_{IL}$	( $I_{OH} = -1 \text{ mA}$ )	2.0	2.0		V	
	$V_{DD} = \text{MIN},$ $V_I = V_{IH} \text{ or } V_{IL}$	( $I_{OH} = -2 \text{ mA}$ )	1.7	1.7		V	
$V_{OL}$	$V_{DD} = \text{MIN},$ $V_I = V_{IH} \text{ or } V_{IL}$	( $I_{OL} = 100 \mu\text{A}$ )	0.2	0.2		V	
	$V_{DD} = \text{MIN},$ $V_I = V_{IH} \text{ or } V_{IL}$	( $I_{OL} = 1 \text{ mA}$ )	0.4	0.4		V	
	$V_{DD} = \text{MIN},$ $V_I = V_{IH} \text{ or } V_{IL}$	( $I_{OL} = 2 \text{ mA}$ )	0.7	0.7		V	
$V_{IL}$	Input Low Voltage, $V_{OUT} \leq V_{VOL(\text{max})}$		-0.3	0.7	-0.3	0.7	V
$V_{IH}$	Input High Voltage, $V_{OUT} \geq V_{VOH(\text{min})}$		1.7	5.75	1.7	5.75	V
$I_{IL}/I_{IH}$	Input Leakage Current, $V_{IN} = V_{CCI} \text{ or GND}$		-10	10	-10	10	$\mu\text{A}$
$I_{OZ}$	Tristate Output Leakage Current, $V_{OUT} = V_{CCI} \text{ or GND}$		-10	10	-10	10	$\mu\text{A}$
$t_R, t_F$	Input Transition Time $t_R, t_F$		10	10		ns	
$C_{IO}$	I/O Capacitance		10	10		pF	
$I_{CC}$	Standby Current		10	20		mA	
IV Curve*	Can be derived from the IBIS model on the web.						

**Note:** \*The IBIS model can be found at <http://www.actel.com/download/ibis/default.aspx>.

## PCI Compliance for the SX-A Family

The SX-A family supports 3.3 V and 5 V PCI and is compliant with the PCI Local Bus Specification Rev. 2.1.

Table 2-7 • DC Specifications (5 V PCI Operation)

Symbol	Parameter	Condition	Min.	Max.	Units
$V_{CCA}$	Supply Voltage for Array		2.25	2.75	V
$V_{CCI}$	Supply Voltage for I/Os		4.75	5.25	V
$V_{IH}$	Input High Voltage		2.0	5.75	V
$V_{IL}$	Input Low Voltage		-0.5	0.8	V
$I_{IH}$	Input High Leakage Current <sup>1</sup>	$V_{IN} = 2.7$	-	70	$\mu A$
$I_{IL}$	Input Low Leakage Current <sup>1</sup>	$V_{IN} = 0.5$	-	-70	$\mu A$
$V_{OH}$	Output High Voltage	$I_{OUT} = -2 \text{ mA}$	2.4	-	V
$V_{OL}$	Output Low Voltage <sup>2</sup>	$I_{OUT} = 3 \text{ mA}, 6 \text{ mA}$	-	0.55	V
$C_{IN}$	Input Pin Capacitance <sup>3</sup>		-	10	pF
$C_{CLK}$	CLK Pin Capacitance		5	12	pF

**Notes:**

1. Input leakage currents include hi-Z output leakage for all bidirectional buffers with tristate outputs.
2. Signals without pull-up resistors must have 3 mA low output current. Signals requiring pull-up must have 6 mA; the latter includes FRAME#, IRDY#, TRDY#, DEVSEL#, STOP#, SERR#, PERR#, LOCK#, and, when used AD[63::32], C/BE[7::4]#, PAR64, REQ64#, and ACK64#.
3. Absolute maximum pin capacitance for a PCI input is 10 pF (except for CLK).

## Output Buffer Delays

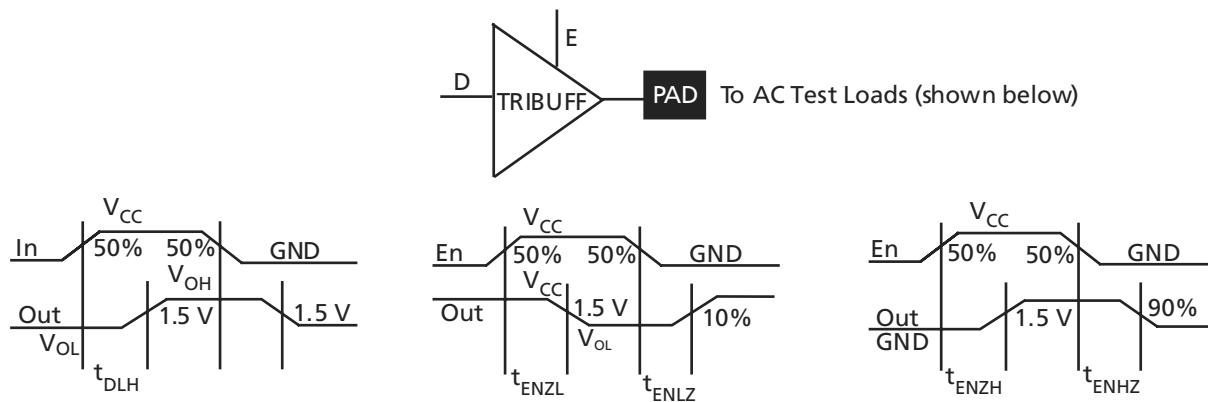


Figure 2-4 • Output Buffer Delays

## AC Test Loads

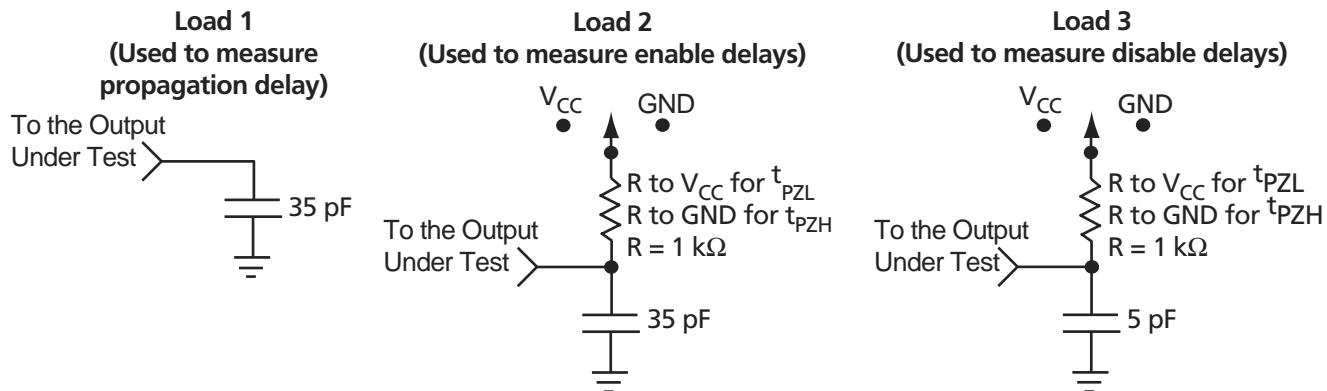


Figure 2-5 • AC Test Loads

## Timing Characteristics

Timing characteristics for SX-A devices fall into three categories: family-dependent, device-dependent, and design-dependent. The input and output buffer characteristics are common to all SX-A family members. Internal routing delays are device-dependent. Design dependency means actual delays are not determined until after placement and routing of the user's design are complete. The timing characteristics listed in this datasheet represent sample timing numbers of the SX-A devices. Design-specific delay values may be determined by using Timer or performing simulation after successful place-and-route with the Designer software.

### Critical Nets and Typical Nets

Propagation delays are expressed only for typical nets, which are used for initial design performance evaluation. Critical net delays can then be applied to the most timing-critical paths. Critical nets are determined by net property assignment prior to placement and routing. Up to 6 percent of the nets in a design may be designated as critical, while 90 percent of the nets in a design are typical.

## Temperature and Voltage Derating Factors

Table 2-13 • Temperature and Voltage Derating Factors  
(Normalized to Worst-Case Commercial,  $T_J = 70^\circ\text{C}$ ,  $V_{CCA} = 2.25 \text{ V}$ )

$V_{CCA}$	Junction Temperature ( $T_J$ )						
	-55°C	-40°C	0°C	25°C	70°C	85°C	125°C
2.250 V	0.79	0.80	0.87	0.89	1.00	1.04	1.14
2.500 V	0.74	0.75	0.82	0.83	0.94	0.97	1.07
2.750 V	0.68	0.69	0.75	0.77	0.87	0.90	0.99

### Long Tracks

Some nets in the design use long tracks. Long tracks are special routing resources that span multiple rows, columns, or modules. Long tracks employ three to five antifuse connections. This increases capacitance and resistance, resulting in longer net delays for macros connected to long tracks. Typically, up to 6 percent of nets in a fully utilized device require long tracks. Long tracks contribute approximately 4 ns to 8.4 ns delay. This additional delay is represented statistically in higher fanout routing delays.

### Timing Derating

SX-A devices are manufactured with a CMOS process. Therefore, device performance varies according to temperature, voltage, and process changes. Minimum timing parameters reflect maximum operating voltage, minimum operating temperature, and best-case processing. Maximum timing parameters reflect minimum operating voltage, maximum operating temperature, and worst-case processing.

Table 2-18 • A54SX08A Timing Characteristics  
(Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.3\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>	<b>-F Speed</b>		<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>2.5 V LVCMOS Output Module Timing<sup>1,2</sup></b>									
$t_{DLH}$	Data-to-Pad Low to High	3.9	4.4	5.2	7.2	ns			
$t_{DHL}$	Data-to-Pad High to Low	3.0	3.4	3.9	5.5	ns			
$t_{DHLS}$	Data-to-Pad High to Low—low slew	13.3	15.1	17.7	24.8	ns			
$t_{ENZL}$	Enable-to-Pad, Z to L	2.8	3.2	3.7	5.2	ns			
$t_{ENZLS}$	Data-to-Pad, Z to L—low slew	13.7	15.5	18.2	25.5	ns			
$t_{ENZH}$	Enable-to-Pad, Z to H	3.9	4.4	5.2	7.2	ns			
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.5	2.8	3.3	4.7	ns			
$t_{ENHZ}$	Enable-to-Pad, H to Z	3.0	3.4	3.9	5.5	ns			
$d_{TLH}^3$	Delta Low to High	0.037	0.043	0.051	0.071	ns/pF			
$d_{THL}^3$	Delta High to Low	0.017	0.023	0.023	0.037	ns/pF			
$d_{THLS}^3$	Delta High to Low—low slew	0.06	0.071	0.086	0.117	ns/pF			

**Note:**

1. Delays based on 35 pF loading.
2. The equivalent I/O Attribute Editor settings for 2.5 V LVCMOS is 2.5 V LVTTL in the software.
3. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$
where  $C_{load}$  is the load capacitance driven by the I/O in pF.  
 $d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.

Table 2-24 • A54SX16A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.2	1.4	1.6	1.8	2.8	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.0	1.1	1.2	1.5	2.2	ns
$t_{HPWH}$	Minimum Pulse Width High	1.4	1.7	1.9	2.2	3.0	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.4	1.7	1.9	2.2	3.0	ns
$t_{HCKSW}$	Maximum Skew	0.3	0.3	0.4	0.4	0.7	ns
$t_{HP}$	Minimum Period	2.8	3.4	3.8	4.4	6.0	ns
$f_{HMAX}$	Maximum Frequency	357	294	263	227	167	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	1.0	1.2	1.3	1.6	2.2	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	1.3	1.5	1.7	2.0	2.8	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	1.3	1.5	1.7	2.0	2.8	ns
$t_{RPWH}$	Minimum Pulse Width High	1.4	1.7	1.9	2.2	3.0	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.4	1.7	1.9	2.2	3.0	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	0.8	0.9	1.0	1.2	1.7	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	0.8	0.9	1.0	1.2	1.7	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	1.0	1.1	1.3	1.5	2.1	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-30 • A54SX32A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.7	2.0	2.2	2.6	4.0	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.7	2.0	2.2	2.6	4.0	ns
$t_{HPWH}$	Minimum Pulse Width High	1.4	1.6	1.8	2.1	2.9	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.4	1.6	1.8	2.1	2.9	ns
$t_{HCKSW}$	Maximum Skew	0.6	0.6	0.7	0.8	1.3	ns
$t_{HP}$	Minimum Period	2.8	3.2	3.6	4.2	5.8	ns
$f_{HMAX}$	Maximum Frequency	357	313	278	238	172	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	2.2	2.5	2.8	3.3	4.6	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	2.1	2.4	2.7	3.2	4.5	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	2.3	2.7	3.1	3.6	5	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	2.2	2.5	2.9	3.4	4.7	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	2.4	2.8	3.2	3.7	5.2	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	2.4	2.8	3.1	3.7	5.1	ns
$t_{RPWH}$	Minimum Pulse Width High	1.4	1.6	1.8	2.1	2.9	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.4	1.6	1.8	2.1	2.9	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	1.0	1.1	1.3	1.5	2.1	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	0.9	1.0	1.2	1.4	1.9	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	0.9	1.0	1.2	1.4	1.9	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-38 • A54SX72A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.6	1.8	2.1	2.4	3.8	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.6	1.9	2.1	2.5	3.8	ns
$t_{HPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{HCKSW}$	Maximum Skew	1.4	1.6	1.8	2.1	3.3	ns
$t_{HP}$	Minimum Period	3.0	3.4	4.0	4.6	6.4	ns
$f_{HMAX}$	Maximum Frequency	333	294	250	217	156	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	2.3	2.6	3.0	3.5	4.9	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	2.8	3.2	3.6	4.3	6.0	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	2.5	2.9	3.2	3.8	5.3	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	3.0	3.4	3.9	4.6	6.4	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	2.6	3.0	3.4	3.9	5.5	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	3.2	3.6	4.1	4.8	6.8	ns
$t_{RPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	1.9	2.2	2.5	3.0	4.1	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	1.9	2.2	2.5	3.0	4.1	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	1.9	2.2	2.5	3.0	4.1	ns
<b>Quadrant Array Clock Networks</b>							
$t_{QCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	1.2	1.4	1.6	1.8	2.6	ns
$t_{QCHKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	1.3	1.4	1.6	1.9	2.7	ns
$t_{QCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	1.4	1.6	1.8	2.1	3.0	ns
$t_{QCHKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	1.4	1.7	1.9	2.2	3.1	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-40 • A54SX72A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>3.3 V PCI Output Module Timing<sup>2</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	2.3	2.7	3.0	3.6	5.0	ns
$t_{DHL}$	Data-to-Pad High to Low	2.5	2.9	3.2	3.8	5.3	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	1.4	1.7	1.9	2.2	3.1	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	2.3	2.7	3.0	3.6	5.0	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.5	2.8	3.2	3.8	5.3	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.5	2.9	3.2	3.8	5.3	ns
$d_{TLH}^3$	Delta Low to High	0.025	0.03	0.03	0.04	0.045	ns/pF
$d_{THL}^3$	Delta High to Low	0.015	0.015	0.015	0.015	0.025	ns/pF
<b>3.3 V LVTTL Output Module Timing<sup>4</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	3.2	3.7	4.2	5.0	6.9	ns
$t_{DHL}$	Data-to-Pad High to Low	3.2	3.7	4.2	4.9	6.9	ns
$t_{DHLS}$	Data-to-Pad High to Low—low slew	10.3	11.9	13.5	15.8	22.2	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	2.2	2.6	2.9	3.4	4.8	ns
$t_{ENZLS}$	Enable-to-Pad, Z to L—low slew	15.8	18.9	21.3	25.4	34.9	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	3.2	3.7	4.2	5.0	6.9	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.9	3.3	3.7	4.4	6.2	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	3.2	3.7	4.2	4.9	6.9	ns
$d_{TLH}^3$	Delta Low to High	0.025	0.03	0.03	0.04	0.045	ns/pF
$d_{THL}^3$	Delta High to Low	0.015	0.015	0.015	0.015	0.025	ns/pF
$d_{THLS}^3$	Delta High to Low—low slew	0.053	0.053	0.067	0.073	0.107	ns/pF

**Notes:**

1. All -3 speed grades have been discontinued.
2. Delays based on 10 pF loading and 25  $\Omega$  resistance.
3. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$
 where  $C_{load}$  is the load capacitance driven by the I/O in pF  
 $d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.
4. Delays based on 35 pF loading.

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
1	GND	GND	GND	GND
2	TDI, I/O	TDI, I/O	TDI, I/O	TDI, I/O
3	I/O	I/O	I/O	I/O
4	NC	I/O	I/O	I/O
5	I/O	I/O	I/O	I/O
6	NC	I/O	I/O	I/O
7	I/O	I/O	I/O	I/O
8	I/O	I/O	I/O	I/O
9	I/O	I/O	I/O	I/O
10	I/O	I/O	I/O	I/O
11	TMS	TMS	TMS	TMS
12	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
13	I/O	I/O	I/O	I/O
14	NC	I/O	I/O	I/O
15	I/O	I/O	I/O	I/O
16	I/O	I/O	I/O	I/O
17	NC	I/O	I/O	I/O
18	I/O	I/O	I/O	GND
19	I/O	I/O	I/O	V <sub>CCA</sub>
20	NC	I/O	I/O	I/O
21	I/O	I/O	I/O	I/O
22	I/O	I/O	I/O	I/O
23	NC	I/O	I/O	I/O
24	I/O	I/O	I/O	I/O
25	NC	NC	NC	I/O
26	GND	GND	GND	GND
27	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
28	GND	GND	GND	GND
29	I/O	I/O	I/O	I/O
30	TRST, I/O	TRST, I/O	TRST, I/O	TRST, I/O
31	NC	I/O	I/O	I/O
32	I/O	I/O	I/O	I/O
33	I/O	I/O	I/O	I/O
34	I/O	I/O	I/O	I/O
35	NC	I/O	I/O	I/O

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
36	I/O	I/O	I/O	I/O
37	I/O	I/O	I/O	I/O
38	I/O	I/O	I/O	I/O
39	NC	I/O	I/O	I/O
40	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
41	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
42	I/O	I/O	I/O	I/O
43	I/O	I/O	I/O	I/O
44	I/O	I/O	I/O	I/O
45	I/O	I/O	I/O	I/O
46	I/O	I/O	I/O	I/O
47	I/O	I/O	I/O	I/O
48	NC	I/O	I/O	I/O
49	I/O	I/O	I/O	I/O
50	NC	I/O	I/O	I/O
51	I/O	I/O	I/O	I/O
52	GND	GND	GND	GND
53	I/O	I/O	I/O	I/O
54	I/O	I/O	I/O	I/O
55	I/O	I/O	I/O	I/O
56	I/O	I/O	I/O	I/O
57	I/O	I/O	I/O	I/O
58	I/O	I/O	I/O	I/O
59	I/O	I/O	I/O	I/O
60	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
61	NC	I/O	I/O	I/O
62	I/O	I/O	I/O	I/O
63	I/O	I/O	I/O	I/O
64	NC	I/O	I/O	I/O
65	I/O	I/O	NC	I/O
66	I/O	I/O	I/O	I/O
67	NC	I/O	I/O	I/O
68	I/O	I/O	I/O	I/O
69	I/O	I/O	I/O	I/O
70	NC	I/O	I/O	I/O

<b>144-Pin TQFP</b>			
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>
1	GND	GND	GND
2	TDI, I/O	TDI, I/O	TDI, I/O
3	I/O	I/O	I/O
4	I/O	I/O	I/O
5	I/O	I/O	I/O
6	I/O	I/O	I/O
7	I/O	I/O	I/O
8	I/O	I/O	I/O
9	TMS	TMS	TMS
10	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
11	GND	GND	GND
12	I/O	I/O	I/O
13	I/O	I/O	I/O
14	I/O	I/O	I/O
15	I/O	I/O	I/O
16	I/O	I/O	I/O
17	I/O	I/O	I/O
18	I/O	I/O	I/O
19	NC	NC	NC
20	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
21	I/O	I/O	I/O
22	TRST, I/O	TRST, I/O	TRST, I/O
23	I/O	I/O	I/O
24	I/O	I/O	I/O
25	I/O	I/O	I/O
26	I/O	I/O	I/O
27	I/O	I/O	I/O
28	GND	GND	GND
29	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
30	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
31	I/O	I/O	I/O
32	I/O	I/O	I/O
33	I/O	I/O	I/O
34	I/O	I/O	I/O
35	I/O	I/O	I/O
36	GND	GND	GND
37	I/O	I/O	I/O

<b>144-Pin TQFP</b>			
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>
38	I/O	I/O	I/O
39	I/O	I/O	I/O
40	I/O	I/O	I/O
41	I/O	I/O	I/O
42	I/O	I/O	I/O
43	I/O	I/O	I/O
44	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
45	I/O	I/O	I/O
46	I/O	I/O	I/O
47	I/O	I/O	I/O
48	I/O	I/O	I/O
49	I/O	I/O	I/O
50	I/O	I/O	I/O
51	I/O	I/O	I/O
52	I/O	I/O	I/O
53	I/O	I/O	I/O
54	PRB, I/O	PRB, I/O	PRB, I/O
55	I/O	I/O	I/O
56	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
57	GND	GND	GND
58	NC	NC	NC
59	I/O	I/O	I/O
60	HCLK	HCLK	HCLK
61	I/O	I/O	I/O
62	I/O	I/O	I/O
63	I/O	I/O	I/O
64	I/O	I/O	I/O
65	I/O	I/O	I/O
66	I/O	I/O	I/O
67	I/O	I/O	I/O
68	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
69	I/O	I/O	I/O
70	I/O	I/O	I/O
71	TDO, I/O	TDO, I/O	TDO, I/O
72	I/O	I/O	I/O
73	GND	GND	GND
74	I/O	I/O	I/O

## 329-Pin PBGA

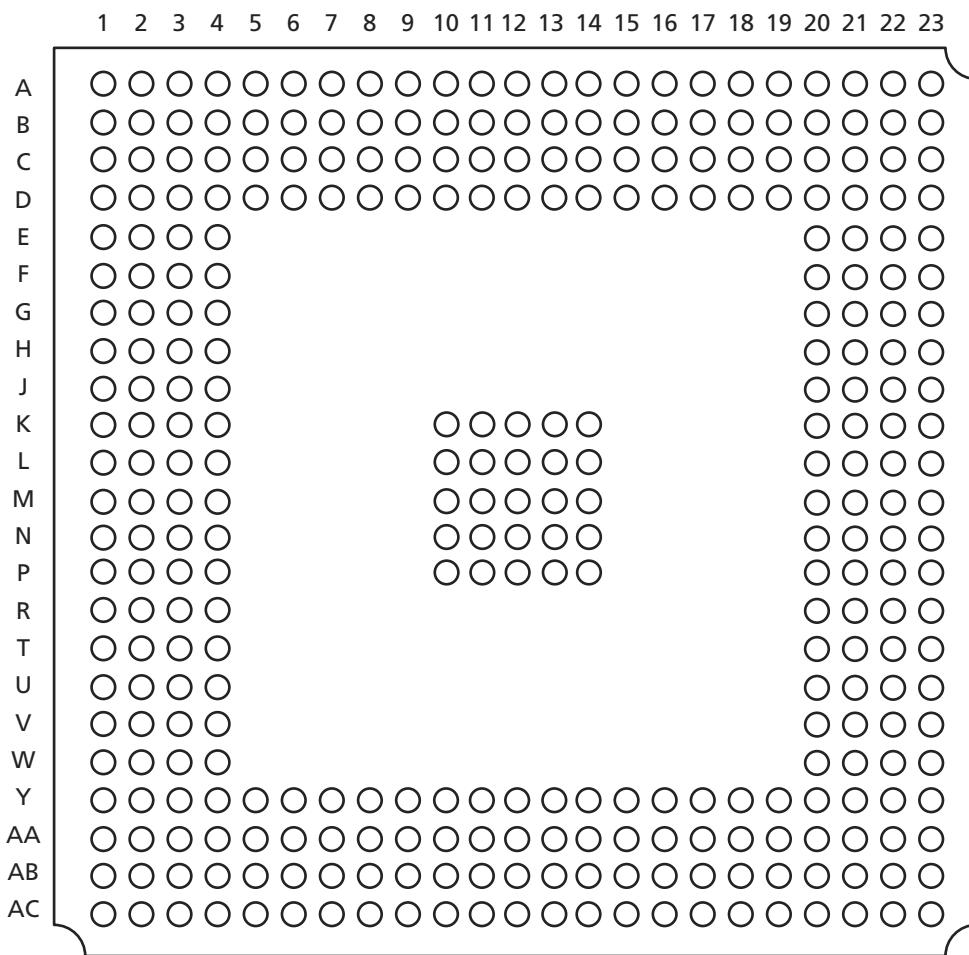


Figure 3-5 • 329-Pin PBGA (Top View)

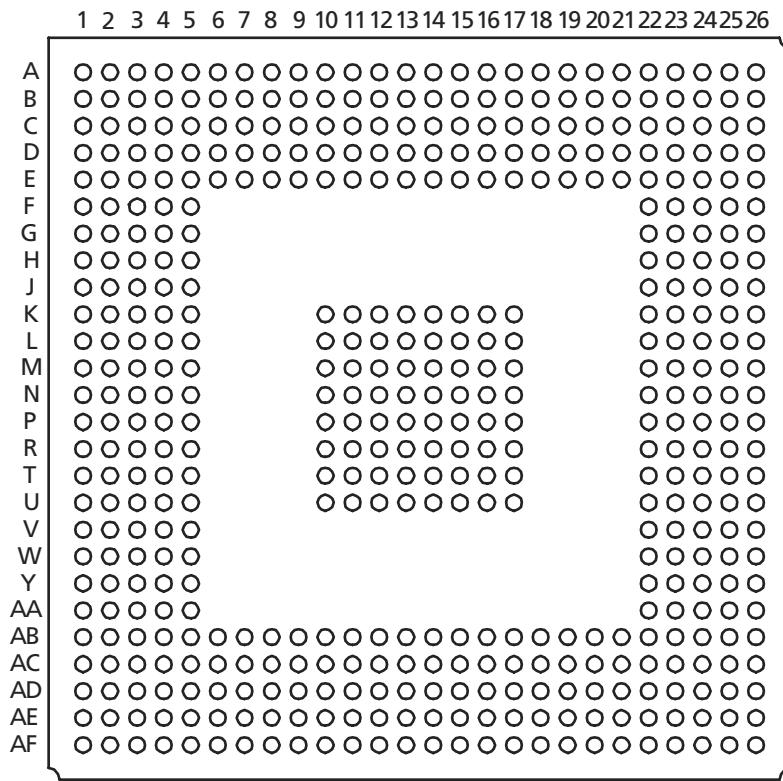
### Note

For Package Manufacturing and Environmental information, visit Resource center at  
<http://www.actel.com/products/rescenter/package/index.html>.

144-Pin FBGA			
Pin Number	A54SX08A Function	A54SX16A Function	A54SX32A Function
A1	I/O	I/O	I/O
A2	I/O	I/O	I/O
A3	I/O	I/O	I/O
A4	I/O	I/O	I/O
A5	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
A6	GND	GND	GND
A7	CLKA	CLKA	CLKA
A8	I/O	I/O	I/O
A9	I/O	I/O	I/O
A10	I/O	I/O	I/O
A11	I/O	I/O	I/O
A12	I/O	I/O	I/O
B1	I/O	I/O	I/O
B2	GND	GND	GND
B3	I/O	I/O	I/O
B4	I/O	I/O	I/O
B5	I/O	I/O	I/O
B6	I/O	I/O	I/O
B7	CLKB	CLKB	CLKB
B8	I/O	I/O	I/O
B9	I/O	I/O	I/O
B10	I/O	I/O	I/O
B11	GND	GND	GND
B12	I/O	I/O	I/O
C1	I/O	I/O	I/O
C2	I/O	I/O	I/O
C3	TCK, I/O	TCK, I/O	TCK, I/O
C4	I/O	I/O	I/O
C5	I/O	I/O	I/O
C6	PRA, I/O	PRA, I/O	PRA, I/O
C7	I/O	I/O	I/O
C8	I/O	I/O	I/O
C9	I/O	I/O	I/O
C10	I/O	I/O	I/O
C11	I/O	I/O	I/O
C12	I/O	I/O	I/O

144-Pin FBGA			
Pin Number	A54SX08A Function	A54SX16A Function	A54SX32A Function
D1	I/O	I/O	I/O
D2	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
D3	TDI, I/O	TDI, I/O	TDI, I/O
D4	I/O	I/O	I/O
D5	I/O	I/O	I/O
D6	I/O	I/O	I/O
D7	I/O	I/O	I/O
D8	I/O	I/O	I/O
D9	I/O	I/O	I/O
D10	I/O	I/O	I/O
D11	I/O	I/O	I/O
D12	I/O	I/O	I/O
E1	I/O	I/O	I/O
E2	I/O	I/O	I/O
E3	I/O	I/O	I/O
E4	I/O	I/O	I/O
E5	TMS	TMS	TMS
E6	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
E7	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
E8	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
E9	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
E10	I/O	I/O	I/O
E11	GND	GND	GND
E12	I/O	I/O	I/O
F1	I/O	I/O	I/O
F2	I/O	I/O	I/O
F3	NC	NC	NC
F4	I/O	I/O	I/O
F5	GND	GND	GND
F6	GND	GND	GND
F7	GND	GND	GND
F8	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
F9	I/O	I/O	I/O
F10	GND	GND	GND
F11	I/O	I/O	I/O
F12	I/O	I/O	I/O

# 484-Pin FBGA



**Figure 3-8 • 484-Pin FBGA (Top View)**

## Note

For Package Manufacturing and Environmental information, visit Resource center at <http://www.actel.com/products/rescenter/package/index.html>.

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
A1	NC*	NC
A2	NC*	NC
A3	NC*	I/O
A4	NC*	I/O
A5	NC*	I/O
A6	I/O	I/O
A7	I/O	I/O
A8	I/O	I/O
A9	I/O	I/O
A10	I/O	I/O
A11	NC*	I/O
A12	NC*	I/O
A13	I/O	I/O
A14	NC*	NC
A15	NC*	I/O
A16	NC*	I/O
A17	I/O	I/O
A18	I/O	I/O
A19	I/O	I/O
A20	I/O	I/O
A21	NC*	I/O
A22	NC*	I/O
A23	NC*	I/O
A24	NC*	I/O
A25	NC*	NC
A26	NC*	NC
AA1	NC*	I/O
AA2	NC*	I/O
AA3	V <sub>CCA</sub>	V <sub>CCA</sub>
AA4	I/O	I/O
AA5	I/O	I/O
AA22	I/O	I/O
AA23	I/O	I/O
AA24	I/O	I/O
AA25	NC*	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
AA26	NC*	I/O
AB1	NC*	NC
AB2	V <sub>CCI</sub>	V <sub>CCI</sub>
AB3	I/O	I/O
AB4	I/O	I/O
AB5	NC*	I/O
AB6	I/O	I/O
AB7	I/O	I/O
AB8	I/O	I/O
AB9	I/O	I/O
AB10	I/O	I/O
AB11	I/O	I/O
AB12	PRB, I/O	PRB, I/O
AB13	V <sub>CCA</sub>	V <sub>CCA</sub>
AB14	I/O	I/O
AB15	I/O	I/O
AB16	I/O	I/O
AB17	I/O	I/O
AB18	I/O	I/O
AB19	I/O	I/O
AB20	TDO, I/O	TDO, I/O
AB21	GND	GND
AB22	NC*	I/O
AB23	I/O	I/O
AB24	I/O	I/O
AB25	NC*	I/O
AB26	NC*	I/O
AC1	I/O	I/O
AC2	I/O	I/O
AC3	I/O	I/O
AC4	NC*	I/O
AC5	V <sub>CCI</sub>	V <sub>CCI</sub>
AC6	I/O	I/O
AC7	V <sub>CCI</sub>	V <sub>CCI</sub>
AC8	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
AC9	I/O	I/O
AC10	I/O	I/O
AC11	I/O	I/O
AC12	I/O	QCLKA
AC13	I/O	I/O
AC14	I/O	I/O
AC15	I/O	I/O
AC16	I/O	I/O
AC17	I/O	I/O
AC18	I/O	I/O
AC19	I/O	I/O
AC20	V <sub>CCI</sub>	V <sub>CCI</sub>
AC21	I/O	I/O
AC22	I/O	I/O
AC23	NC*	I/O
AC24	I/O	I/O
AC25	NC*	I/O
AC26	NC*	I/O
AD1	I/O	I/O
AD2	I/O	I/O
AD3	GND	GND
AD4	I/O	I/O
AD5	I/O	I/O
AD6	I/O	I/O
AD7	I/O	I/O
AD8	I/O	I/O
AD9	V <sub>CCI</sub>	V <sub>CCI</sub>
AD10	I/O	I/O
AD11	I/O	I/O
AD12	I/O	I/O
AD13	V <sub>CCI</sub>	V <sub>CCI</sub>
AD14	I/O	I/O
AD15	I/O	I/O
AD16	I/O	I/O
AD17	V <sub>CCI</sub>	V <sub>CCI</sub>

**Note:** \*These pins must be left floating on the A54SX32A device.

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
AD18	I/O	I/O
AD19	I/O	I/O
AD20	I/O	I/O
AD21	I/O	I/O
AD22	I/O	I/O
AD23	V <sub>CCI</sub>	V <sub>CCI</sub>
AD24	NC*	I/O
AD25	NC*	I/O
AD26	NC*	I/O
AE1	NC*	NC
AE2	I/O	I/O
AE3	NC*	I/O
AE4	NC*	I/O
AE5	NC*	I/O
AE6	NC*	I/O
AE7	I/O	I/O
AE8	I/O	I/O
AE9	I/O	I/O
AE10	I/O	I/O
AE11	NC*	I/O
AE12	I/O	I/O
AE13	I/O	I/O
AE14	I/O	I/O
AE15	NC*	I/O
AE16	NC*	I/O
AE17	I/O	I/O
AE18	I/O	I/O
AE19	I/O	I/O
AE20	I/O	I/O
AE21	NC*	I/O
AE22	NC*	I/O
AE23	NC*	I/O
AE24	NC*	I/O
AE25	NC*	NC
AE26	NC*	NC

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
AF1	NC*	NC
AF2	NC*	NC
AF3	NC	I/O
AF4	NC*	I/O
AF5	NC*	I/O
AF6	NC*	I/O
AF7	I/O	I/O
AF8	I/O	I/O
AF9	I/O	I/O
AF10	I/O	I/O
AF11	NC*	I/O
AF12	NC*	NC
AF13	HCLK	HCLK
AF14	I/O	QCLKB
AF15	NC*	I/O
AF16	NC*	I/O
AF17	I/O	I/O
AF18	I/O	I/O
AF19	I/O	I/O
AF20	NC*	I/O
AF21	NC*	I/O
AF22	NC*	I/O
AF23	NC*	I/O
AF24	NC*	I/O
AF25	NC*	NC
AF26	NC*	NC
B1	NC*	NC
B2	NC*	NC
B3	NC*	I/O
B4	NC*	I/O
B5	NC*	I/O
B6	I/O	I/O
B7	I/O	I/O
B8	I/O	I/O
B9	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
B10	I/O	I/O
B11	NC*	I/O
B12	NC*	I/O
B13	V <sub>CCI</sub>	V <sub>CCI</sub>
B14	CLKA	CLKA
B15	NC*	I/O
B16	NC*	I/O
B17	I/O	I/O
B18	V <sub>CCI</sub>	V <sub>CCI</sub>
B19	I/O	I/O
B20	I/O	I/O
B21	NC*	I/O
B22	NC*	I/O
B23	NC*	I/O
B24	NC*	I/O
B25	I/O	I/O
B26	NC*	NC
C1	NC*	I/O
C2	NC*	I/O
C3	NC*	I/O
C4	NC*	I/O
C5	I/O	I/O
C6	V <sub>CCI</sub>	V <sub>CCI</sub>
C7	I/O	I/O
C8	I/O	I/O
C9	V <sub>CCI</sub>	V <sub>CCI</sub>
C10	I/O	I/O
C11	I/O	I/O
C12	I/O	I/O
C13	PRA, I/O	PRA, I/O
C14	I/O	I/O
C15	I/O	QCLKD
C16	I/O	I/O
C17	I/O	I/O
C18	I/O	I/O

**Note:** \*These pins must be left floating on the A54SX32A device.

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
C19	I/O	I/O
C20	V <sub>CCI</sub>	V <sub>CCI</sub>
C21	I/O	I/O
C22	I/O	I/O
C23	I/O	I/O
C24	I/O	I/O
C25	NC*	I/O
C26	NC*	I/O
D1	NC*	I/O
D2	TMS	TMS
D3	I/O	I/O
D4	V <sub>CCI</sub>	V <sub>CCI</sub>
D5	NC*	I/O
D6	TCK, I/O	TCK, I/O
D7	I/O	I/O
D8	I/O	I/O
D9	I/O	I/O
D10	I/O	I/O
D11	I/O	I/O
D12	I/O	QCLKC
D13	I/O	I/O
D14	I/O	I/O
D15	I/O	I/O
D16	I/O	I/O
D17	I/O	I/O
D18	I/O	I/O
D19	I/O	I/O
D20	I/O	I/O
D21	V <sub>CCI</sub>	V <sub>CCI</sub>
D22	GND	GND
D23	I/O	I/O
D24	I/O	I/O
D25	NC*	I/O
D26	NC*	I/O
E1	NC*	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
E2	NC*	I/O
E3	I/O	I/O
E4	I/O	I/O
E5	GND	GND
E6	TDI, IO	TDI, IO
E7	I/O	I/O
E8	I/O	I/O
E9	I/O	I/O
E10	I/O	I/O
E11	I/O	I/O
E12	I/O	I/O
E13	V <sub>CCA</sub>	V <sub>CCA</sub>
E14	CLKB	CLKB
E15	I/O	I/O
E16	I/O	I/O
E17	I/O	I/O
E18	I/O	I/O
E19	I/O	I/O
E20	I/O	I/O
E21	I/O	I/O
E22	I/O	I/O
E23	I/O	I/O
E24	I/O	I/O
E25	V <sub>CCI</sub>	V <sub>CCI</sub>
E26	GND	GND
F1	V <sub>CCI</sub>	V <sub>CCI</sub>
F2	NC*	I/O
F3	NC*	I/O
F4	I/O	I/O
F5	I/O	I/O
F22	I/O	I/O
F23	I/O	I/O
F24	I/O	I/O
F25	I/O	I/O
F26	NC*	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
G1	NC*	I/O
G2	NC*	I/O
G3	NC*	I/O
G4	I/O	I/O
G5	I/O	I/O
G22	I/O	I/O
G23	V <sub>CCA</sub>	V <sub>CCA</sub>
G24	I/O	I/O
G25	NC*	I/O
G26	NC*	I/O
H1	NC*	I/O
H2	NC*	I/O
H3	I/O	I/O
H4	I/O	I/O
H5	I/O	I/O
H22	I/O	I/O
H23	I/O	I/O
H24	I/O	I/O
H25	NC*	I/O
H26	NC*	I/O
J1	NC*	I/O
J2	NC*	I/O
J3	I/O	I/O
J4	I/O	I/O
J5	I/O	I/O
J22	I/O	I/O
J23	I/O	I/O
J24	I/O	I/O
J25	V <sub>CCI</sub>	V <sub>CCI</sub>
J26	NC*	I/O
K1	I/O	I/O
K2	V <sub>CCI</sub>	V <sub>CCI</sub>
K3	I/O	I/O
K4	I/O	I/O
K5	V <sub>CCA</sub>	V <sub>CCA</sub>

**Note:** \*These pins must be left floating on the A54SX32A device.